

HSBC OVERSEAS SCHOLARSHIP 2018/19 UNIVERSITY RECOMMENDATION

APPLICANT'S PERSONAL INFORMATION

Name: _____ Chinese name: _____

Gender: _____ Birth date: _____ HK I/D card no.: _____

Place of birth: _____ Years of residency in Hong Kong: _____

Citizenship(s): _____

Father's occupation: _____ Mother's occupation: _____

Family* income[#]: HKD _____ per month Number of family* members: _____

Recipient of government loan (Y/N): _____ Amount: HKD _____

Recipient of government grant / subsidies / allowances (Please specify type): _____ Amount: HKD _____

Home address: _____

Contact number (s): _____ E-mail address: (school) _____ (permanent) _____

Overseas residency / studying / travelling experience (Y/N): _____ If yes, duration/details: _____

Hobbies: _____

Please affix
recent photo here

Name of local university: _____

Name of degree course: _____ Duration: _____ Current year of study: _____

GPA score: _____ CGPA _____ 2017/18 1st semester _____ 2016/17 (if applicable) _____ Please attach transcript for reference

Name of target overseas university: _____

Choice of discipline at the overseas university: _____

Summary of rating
(to be completed by university):

| | Excellent | Good | Satisfactory |
|-------------------------|-----------|-------|--------------|
| Intellectual ability | _____ | _____ | _____ |
| Analytical power | _____ | _____ | _____ |
| Creativity | _____ | _____ | _____ |
| Leadership | _____ | _____ | _____ |
| Communication skills | _____ | _____ | _____ |
| All-roundedness | _____ | _____ | _____ |
| Commitment to Hong Kong | _____ | _____ | _____ |

* Family is defined as applicant, applicant's spouse/parents/siblings/children and any other persons who are financially dependent on the aforementioned members.

Applicant may be required to submit supporting documentation to substantiate his/her declaration.

ACADEMIC RECORD (continued)

English proficiency test – Date of test (must be 9 February 2016 or later): _____

| | Total Score (min 90) | Listening (min 22) | Writing (min 17) | Reading (min 21) | Speaking (min 21) |
|-------|---------------------------|------------------------|----------------------|----------------------|-----------------------|
| TOEFL | _____ | _____ | _____ | _____ | _____ |
| or | Overall Band (min 6.5) | Listening (min 6.0) | Reading (min 6.0) | Writing (min 6.0) | Speaking (min 6.0) |
| IELTS | _____ | _____ | _____ | _____ | _____ |

Note: To be eligible, your scores must be above the minimum stated above in each category.

TO BE COMPLETED BY THE APPLICANT

IMPORTANT: PLEASE USE THE SPACE PROVIDED BELOW. ADDITIONAL ATTACHMENTS WILL NOT BE REVIEWED.

Extra-curricular activities and community service:
(Please list in chronological order.)

Secondary School:
(Please list in chronological order.)

Work experience (full-time and part-time):
(Please list in chronological order.)

PERSONAL INFORMATION COLLECTION STATEMENT

Purpose of collection

The personal data provided in this form and any other information (the “Information”) that may be provided for the purposes of the application for “HSBC Overseas Scholarship 2018/19” (the “Programme”) will be used by the Hongkong Bank Foundation (the “Foundation”) and The Hongkong and Shanghai Banking Corporation Limited (“HSBC”) and their agents/contractors for one or more of the following purposes and any directly related purpose, in respect of the “HSBC Overseas Scholarship 2018/19”:

(i) to consider, process and administer your application, and serve any directly related purposes, e.g. processing and administering the scholarship under the Programme (if granted), and to communicate with you.

(ii) any other purposes as may be required, authorised or permitted by any law and/or regulation.

It is voluntary for you to supply the Information but if you fail to supply any of the Information required by this form, your application may not be processed.

Access to personal data

Except where there is an exemption provided under the Personal Data (Privacy) Ordinance (Cap. 486), you have the right to request access to and correction of your personal data provided in this form when the data have not been erased. Your right of access includes the right to obtain a copy of your personal data provided in this form subject to payment of a fee.

Request and enquiry

Your request for access to personal data or enquiry regarding personal data privacy policy should be addressed to:

The Data Protection Officer
The Hongkong and Shanghai Banking Corporation Limited
PO Box 72677
Kowloon Central Post Office
Hong Kong
Re: HSBC Overseas Scholarship 2018/19
E-mail: dfv.enquiry@hsbc.com.hk

DECLARATION BY THE APPLICANT

I, _____ (Name in full), understand that I am required to disclose position held in or affiliation with HSBC, which can be viewed as presenting an actual or potential conflict of interest in applying for HSBC Scholarships. The more easily identifiable conflicts of interests are student apprenticeship in HSBC or having close personal relationship working in HSBC.

I declare that:

I have no actual or potential conflict of interest that could directly or indirectly affect my application to HSBC Scholarships, which may lead to bias and loss of impartiality. I will report such actual or potential conflict of interest should it arise.

I have the following position held in HSBC or affiliation with HSBC for your assessment of conflict of interest:

Student internship / placement in HSBC:

Department: _____

Internship / placement period: _____

Name of supervisor: _____

Close relatives or personal relationship working in HSBC:

Name: _____

Job title: _____

Relationship with the Applicant: _____

Name: _____

Job title: _____

Relationship with the Applicant: _____

Any other actual or potential conflict of interest:

I declare that the Information provided in this Scholarship application is accurate, true and complete to the best of my knowledge. I am aware that the Foundation/HSBC will rely, and consent to the Foundation/HSBC relying, on the Information provided by me to determine the eligibility for the scholarship and the amount of the scholarship to be offered to me.

I confirm that I have carefully read and fully understand the “Personal Information Collection Statement” (the “PICS”) set out above. I accept the PICS and the purposes of use of the Information set out in it.

I confirm that each of the family members and other persons in respect of which the Information is provided in or in relation to this application (the “Relevant Person(s)”) has been notified of and agreed to the PICS and the purposes of use of the Information set out in it. I shall advise each Relevant Person that he/she has rights of access to, and correction of, his/her personal data. I agree to inform the Foundation/HSBC promptly in writing if I am not able or have failed to comply with the obligations set out in this paragraph in any respect.

I authorise and consent to my university releasing my personal data held by it to the Foundation/HSBC in order for it to use such information for such purposes set out in the PICS.

I authorise the Foundation to (i) transfer the Information to HSBC and for HSBC to use the Information for such purposes set out in the PICS; and (ii) release the results of my application to my university or institution.

Signature of the Applicant: _____

Name in full: _____

HKID Number: _____

Date: _____

UNIVERSITY RECOMMENDATION (Please use the space provided)

I certify that the above-named applicant has been interviewed by the members of the selection panel and he/she is considered eligible for admission to the Programme and the overseas university named above.

I understand that the information collected will be kept confidential and used by the Hongkong Bank Foundation/HSBC to process the scholarship application and for the purposes set out in the PICS above. The Hongkong Bank Foundation/HSBC will not disclose the information collected to any external organisation (other than as stated in the PICS above) unless we have the Applicant’s and our consent or are required by law.

Signature: _____
(signature with official chop)

Date: _____

Name: _____

Title: _____